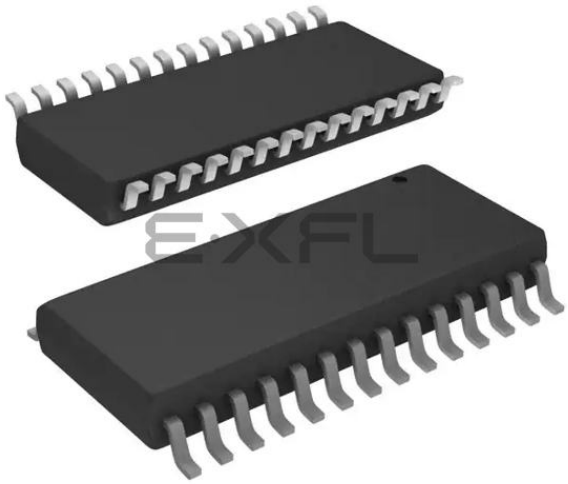

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	CANbus, I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	22
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f258t-i-so

TABLE 1-2: PIC18FXX8 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	PIC18F248/258	PIC18F448/458					
	SPDIP, SOIC	PDIP	TQFP	PLCC			
							PORTC is a bidirectional I/O port.
RC0/T1OSO/T1CKI	11	15	32	16			
RC0					I/O	ST	Digital I/O.
T1OSO					O	—	Timer1 oscillator output.
T1CKI					I	ST	Timer1/Timer3 external clock input.
RC1/T1OSI	12	16	35	18			
RC1					I/O	ST	Digital I/O.
T1OSI					I	CMOS	Timer1 oscillator input.
RC2/CCP1	13	17	36	19			
RC2					I/O	ST	Digital I/O.
CCP1					I/O	ST	Capture 1 input/Compare 1 output/PWM1 output.
RC3/SCK/SCL	14	18	37	20			
RC3					I/O	ST	Digital I/O.
SCK					I/O	ST	Synchronous serial clock input/output for SPI™ mode.
SCL					I/O	ST	Synchronous serial clock input/output for I^2C™ mode.
RC4/SDI/SDA	15	23	42	25			
RC4					I/O	ST	Digital I/O.
SDI					I	ST	SPI data in.
SDA					I/O	ST	I^2C data I/O.
RC5/SDO	16	24	43	26			
RC5					I/O	ST	Digital I/O.
SDO					O	—	SPI data out.
RC6/TX/CK	17	25	44	27			
RC6					I/O	ST	Digital I/O.
TX					O	—	USART asynchronous transmit.
CK					I/O	ST	USART synchronous clock (see RX/DT).
RC7/RX/DT	18	26	1	29			
RC7					I/O	ST	Digital I/O.
RX					I	ST	USART asynchronous receive.
DT					I/O	ST	USART synchronous data (see TX/CK).

Legend: TTL = TTL compatible input
ST = Schmitt Trigger input with CMOS levels
I = Input
P = Power
CMOS = CMOS compatible input or output
Analog = Analog input
O = Output
OD = Open-Drain (no P diode to V_{DD})

REGISTER 6-1: EECON1: EEPROM CONTROL REGISTER 1

R/W-x	R/W-x	U-0	R/W-0	R/W-x	R/W-0	R/S-0	R/S-0
EEPGD	CFGS	—	FREE	WRERR	WREN	$\overline{WR}$	$\overline{RD}$
bit 7							bit 0

bit 7 **EEPGD:** Flash Program or Data EEPROM Memory Select bit
1 = Access program Flash memory
0 = Access data EEPROM memory

bit 6 **CFGS:** Flash Program/Data EE or Configuration Select bit
1 = Access Configuration registers
0 = Access program Flash or data EEPROM memory

bit 5 **Unimplemented:** Read as '0'

bit 4 **FREE:** Flash Row Erase Enable bit
1 = Erase the program memory row addressed by TBLPTR on the next $\overline{WR}$ command (cleared by completion of erase operation)
0 = Perform write only

bit 3 **WRERR:** Write Error Flag bit
1 = A write operation is prematurely terminated (any $\overline{MCLR}$ or any WDT Reset during self-timed programming in normal operation)
0 = The write operation completed

Note: When a WRERR occurs, the EEPGD and CFGS bits are not cleared. This allows tracing of the error condition.

bit 2 **WREN:** Write Enable bit
1 = Allows write cycles
0 = Inhibits write to the EEPROM or Flash memory

bit 1 **$\overline{WR}$:** Write Control bit
1 = Initiates a data EEPROM erase/write cycle or a program memory erase cycle or write cycle (The operation is self-timed and the bit is cleared by hardware once write is complete. The $\overline{WR}$ bit can only be set (not cleared) in software.)
0 = Write cycle to the EEPROM is complete

bit 0 **$\overline{RD}$:** Read Control bit
1 = Initiates an EEPROM read (Read takes one cycle. $\overline{RD}$ is cleared in hardware. The $\overline{RD}$ bit can only be set (not cleared) in software. $\overline{RD}$ bit cannot be set when EEPGD = 1.)
0 = Does not initiate an EEPROM read

Legend:			
R = Readable bit	W = Writable bit	S = Settable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

12.0 TIMER1 MODULE

The Timer1 module timer/counter has the following features:

- 16-bit timer/counter
  (two 8-bit registers: TMR1H and TMR1L)
- Readable and writable (both registers)
- Internal or external clock select
- Interrupt-on-overflow from FFFFh to 0000h
- Reset from CCP module special event trigger

Register 12-1 shows the Timer1 Control register. This register controls the operating mode of the Timer1 module, as well as contains the Timer1 Oscillator Enable bit (T1OSCEN). Timer1 can be enabled/disabled by setting/clearing control bit, TMR1ON (T1CON register).

Figure 12-1 is a simplified block diagram of the Timer1 module.

Note:	Timer1 is disabled on POR.

REGISTER 12-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RD16	—	T1CKPS1	T1CKPS0	T1OSCEN	$\overline{\text{T1SYNC}}$	TMR1CS	TMR1ON
bit 7							bit 0

bit 7 **RD16:** 16-bit Read/Write Mode Enable bit
1 = Enables register read/write of Timer1 in one 16-bit operation
0 = Enables register read/write of Timer1 in two 8-bit operations

bit 6 **Unimplemented:** Read as '0'

bit 5-4 **T1CKPS1:T1CKPS0**: Timer1 Input Clock Prescale Select bits
11 = 1:8 Prescale value
10 = 1:4 Prescale value
01 = 1:2 Prescale value
00 = 1:1 Prescale value

bit 3 **T1OSCEN:** Timer1 Oscillator Enable bit
1 = Timer1 oscillator is enabled
0 = Timer1 oscillator is shut-off
The oscillator inverter and feedback resistor are turned off to eliminate power drain.

bit 2 **$\overline{\text{T1SYNC}}$:** Timer1 External Clock Input Synchronization Select bit
When TMR1CS = 1:
1 = Do not synchronize external clock input
0 = Synchronize external clock input
When TMR1CS = 0:
This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.

bit 1 **TMR1CS:** Timer1 Clock Source Select bit
1 = External clock from pin RC0/T1OSO/T1CKI (on the rising edge)
0 = Internal clock (FOSC/4)

bit 0 **TMR1ON:** Timer1 On bit
1 = Enables Timer1
0 = Stops Timer1

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

14.0 TIMER3 MODULE

The Timer3 module timer/counter has the following features:

- 16-bit timer/counter
  (two 8-bit registers: TMR3H and TMR3L)
- Readable and writable (both registers)
- Internal or external clock select
- Interrupt-on-overflow from FFFFh to 0000h
- Reset from CCP1/ECCP1 module trigger

Figure 14-1 is a simplified block diagram of the Timer3 module.

Register 14-1 shows the Timer3 Control register. This register controls the operating mode of the Timer3 module and sets the CCP1 and ECCP1 clock source.

Register 12-1 shows the Timer1 Control register. This register controls the operating mode of the Timer1 module, as well as contains the Timer1 Oscillator Enable bit (T1OSCEN) which can be a clock source for Timer3.

Note:	Timer3 is disabled on POR.

REGISTER 14-1: T3CON:TIMER3 CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RD16	T3ECCP1	T3CKPS1	T3CKPS0	T3CCP1	$\overline{\text{T3SYNC}}$	TMR3CS	TMR3ON
bit 7							bit 0

bit 7 **RD16:** 16-bit Read/Write Mode Enable bit
1 = Enables register read/write of Timer3 in one 16-bit operation
0 = Enables register read/write of Timer3 in two 8-bit operations

bit 6,3 **T3ECCP1:T3CCP1:** Timer3 and Timer1 to CCP1/ECCP1 Enable bits
1x = Timer3 is the clock source for compare/capture CCP1 and ECCP1 modules
01 = Timer3 is the clock source for compare/capture of ECCP1,
Timer1 is the clock source for compare/capture of CCP1
00 = Timer1 is the clock source for compare/capture CCP1 and ECCP1 modules

bit 5-4 **T3CKPS1:T3CKPS0**: Timer3 Input Clock Prescale Select bits
11 = 1:8 Prescale value
10 = 1:4 Prescale value
01 = 1:2 Prescale value
00 = 1:1 Prescale value

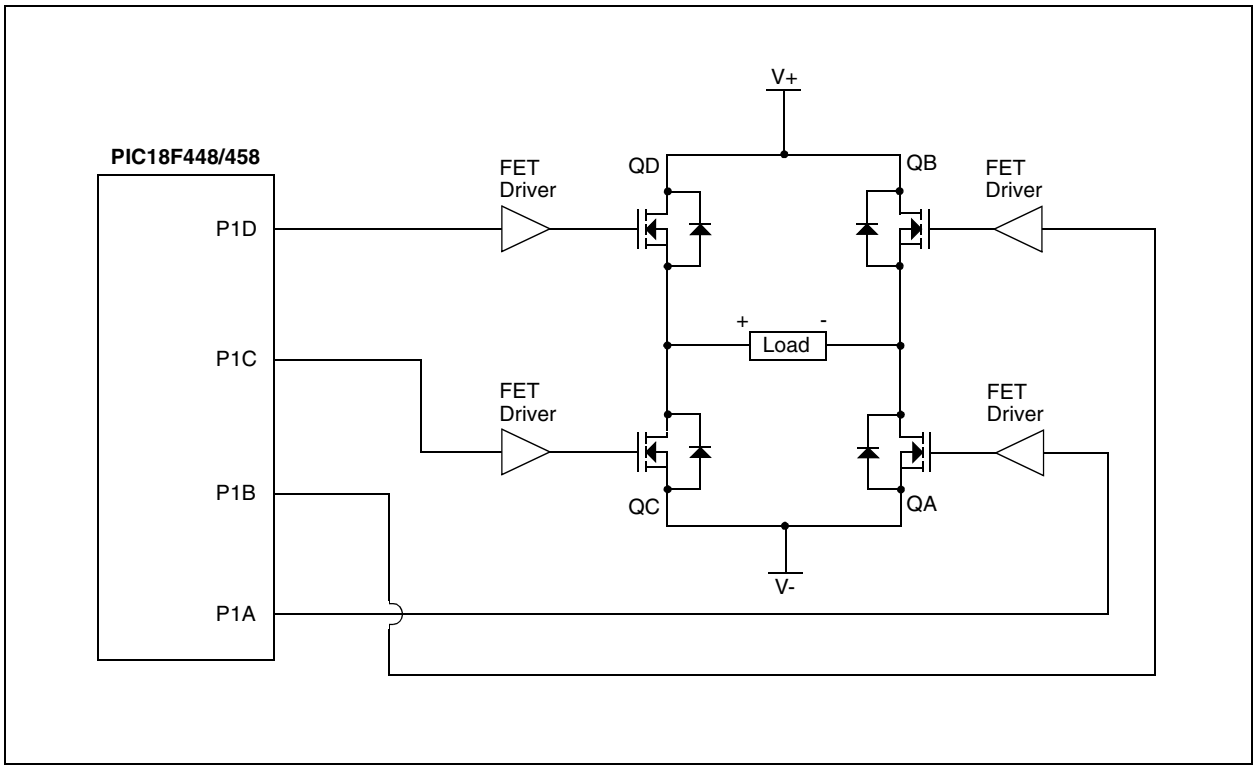
bit 2 **T3SYNC:** Timer3 External Clock Input Synchronization Control bit
(Not usable if the system clock comes from Timer1/Timer3.)
When TMR3CS = 1:
1 = Do not synchronize external clock input
0 = Synchronize external clock input
When TMR3CS = 0:
This bit is ignored. Timer3 uses the internal clock when TMR3CS = 0.

bit 1 **TMR3CS:** Timer3 Clock Source Select bit
1 = External clock input from Timer1 oscillator or T1CKI (on the rising edge after the first falling edge)
0 = Internal clock (FOSC/4)

bit 0 **TMR3ON:** Timer3 On bit
1 = Enables Timer3
0 = Stops Timer3

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

FIGURE 16-6: EXAMPLE OF FULL-BRIDGE APPLICATION



16.5.3.1 Direction Change in Full-Bridge Mode

In the Full-Bridge Output mode, the EPWM1M1 bit in the ECCP1CON register allows the user to control the forward/reverse direction. When the application firmware changes this direction control bit, the ECCP1 module will assume the new direction on the next PWM cycle. The current PWM cycle still continues, however, the non-modulated outputs, P1A and P1C signals, will transition to the new direction TOSC, 4 TOSC or 16 TOSC earlier (for T2CKRS<1:0> = `00`, `01` or `1x`, respectively) before the end of the period. During this transition cycle, the modulated outputs, P1B and P1D, will go to the inactive state (Figure 16-7).

Note that in the Full-Bridge Output mode, the ECCP module does not provide any dead-band delay. In general, since only one output is modulated at all times, dead-band delay is not required. However, there is a situation where a dead-band delay might be required. This situation occurs when all of the following conditions are true:

1. The direction of the PWM output changes when the duty cycle of the output is at or near 100%.
2. The turn-off time of the power switch, including the power device and driver circuit, is greater than turn-on time.

Figure 16-8 shows an example where the PWM direction changes from forward to reverse at a near 100% duty cycle. At time t1, the outputs P1A and P1D become inactive, while output P1C becomes active. In this example, since the turn-off time of the power devices is longer than the turn-on time, a shoot-through current flows through power devices QB and QD (see Figure 16-6) for the duration of 't'. The same phenomenon will occur to power devices QA and QC for PWM direction change from reverse to forward.

If changing PWM direction at high duty cycle is required for an application, one of the following requirements must be met:

1. Avoid changing PWM output direction at or near 100% duty cycle.
2. Use switch drivers that compensate the slow turn off of the power devices. The total turn-off time (t_{off}) of the power device and the driver must be less than the turn-on time (t_{on}).

17.4.2 OPERATION

The MSSP module functions are enabled by setting MSSP Enable bit, SSPEN (SSPCON1<5>).

The SSPCON1 register allows control of the I^2C operation. Four mode selection bits (SSPCON1<3:0>) allow one of the following I^2C modes to be selected:

- I^2C Master mode, clock = OSC/4 (SSPADD +1)
- I^2C Slave mode (7-bit address)
- I^2C Slave mode (10-bit address)
- I^2C Slave mode (7-bit address) with Start and Stop bit interrupts enabled
- I^2C Slave mode (10-bit address) with Start and Stop bit interrupts enabled
- I^2C Firmware Controlled Master mode, slave is Idle

Selection of any I^2C mode with the SSPEN bit set forces the SCL and SDA pins to be open-drain, provided these pins are programmed to inputs by setting the appropriate TRISC bits. To ensure proper operation of the module, pull-up resistors must be provided externally to the SCL and SDA pins.

17.4.3 SLAVE MODE

In Slave mode, the SCL and SDA pins must be configured as inputs (TRISC<4:3> set). The MSSP module will override the input state with the output data when required (slave-transmitter).

The I^2C Slave mode hardware will always generate an interrupt on an address match. Through the mode select bits, the user can also choose to interrupt on Start and Stop bits.

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge ($\overline{ACK}$) pulse and load the SSPBUF register with the received value currently in the SSPSR register.

Any combination of the following conditions will cause the MSSP module not to give this $\overline{ACK}$ pulse:

- The Buffer Full bit, BF (SSPSTAT<0>), was set before the transfer was received.
- The overflow bit, SSPOV (SSPCON1<6>), was set before the transfer was received.

In this case, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF (PIR1<3>) is set. The BF bit is cleared by reading the SSPBUF register, while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low for proper operation. The high and low times of the I^2C specification, as well as the requirement of the MSSP module, are shown in timing parameter #100 and parameter #101.

17.4.3.1 Addressing

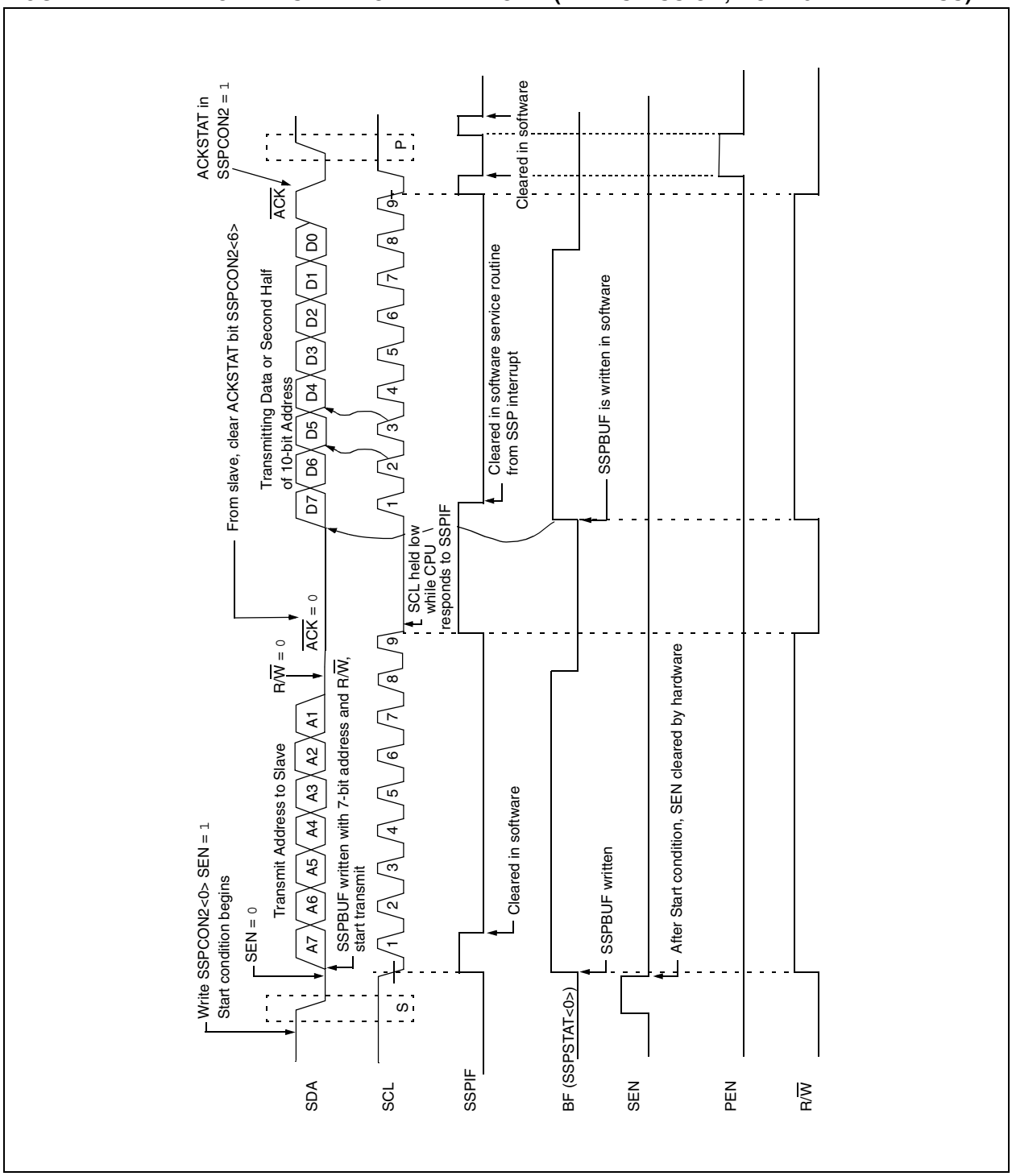
Once the MSSP module has been enabled, it waits for a Start condition to occur. Following the Start condition, the 8 bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match and the BF and SSPOV bits are clear, the following events occur:

1. The SSPSR register value is loaded into the SSPBUF register.
2. The Buffer Full bit BF is set.
3. An $\overline{ACK}$ pulse is generated.
4. MSSP Interrupt Flag bit, SSPIF (PIR1<3>), is set (interrupt is generated if enabled) on the falling edge of the ninth SCL pulse.

In 10-bit Address mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/$\overline{W}$ (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '`11110 A9 A8 0`', where '`A9`' and '`A8`' are the two MSbs of the address. The sequence of events for 10-bit address is as follows, with steps 7 through 9 for the slave-transmitter:

1. Receive first (high) byte of address (bits SSPIF, BF and bit UA (SSPSTAT<1>) are set).
2. Update the SSPADD register with second (low) byte of address (clears bit UA and releases the SCL line).
3. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
4. Receive second (low) byte of address (bits SSPIF, BF and UA are set).
5. Update the SSPADD register with the first (high) byte of address. If match releases SCL line, this will clear bit UA.
6. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
7. Receive Repeated Start condition.
8. Receive first (high) byte of address (bits SSPIF and BF are set).
9. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

FIGURE 17-21: I²C™ MASTER MODE WAVEFORM (TRANSMISSION, 7 OR 10-BIT ADDRESS)



17.4.12 ACKNOWLEDGE SEQUENCE TIMING

An Acknowledge sequence is enabled by setting the Acknowledge Sequence Enable bit, ACKEN (SSPCON2<4>). When this bit is set, the SCL pin is pulled low and the contents of the Acknowledge data bit are presented on the SDA pin. If the user wishes to generate an Acknowledge, then the ACKDT bit should be cleared. If not, the user should set the ACKDT bit before starting an Acknowledge sequence. The Baud Rate Generator then counts for one rollover period (TBRG) and the SCL pin is deasserted (pulled high). When the SCL pin is sampled high (clock arbitration), the Baud Rate Generator counts for TBRG. The SCL pin is then pulled low. Following this, the ACKEN bit is automatically cleared, the Baud Rate Generator is turned off and the MSSP module then goes into Idle mode (Figure 17-23).

17.4.12.1 WCOL Status Flag

If the user writes the SSPBUF when an Acknowledge sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

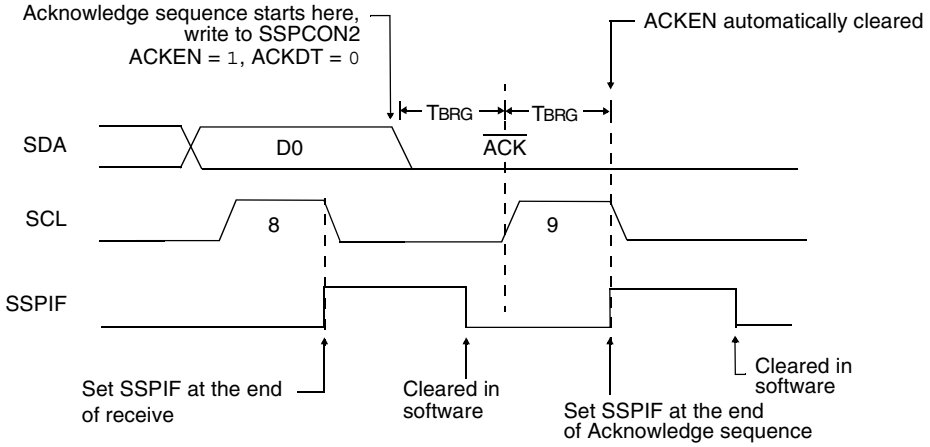
17.4.13 STOP CONDITION TIMING

A Stop bit is asserted on the SDA pin at the end of a receive/transmit by setting the Stop Sequence Enable bit, PEN (SSPCON2<2>). At the end of a receive/transmit, the SCL line is held low after the falling edge of the ninth clock. When the PEN bit is set, the master will assert the SDA line low. When the SDA line is sampled low, the Baud Rate Generator is reloaded and counts down to 0. When the Baud Rate Generator times out, the SCL pin will be brought high and one TBRG (Baud Rate Generator rollover count) later, the SDA pin will be deasserted. When the SDA pin is sampled high while SCL is high, the P bit (SSPSTAT<4>) is set. A TBRG later, the PEN bit is cleared and the SSPIF bit is set (Figure 17-24).

17.4.13.1 WCOL Status Flag

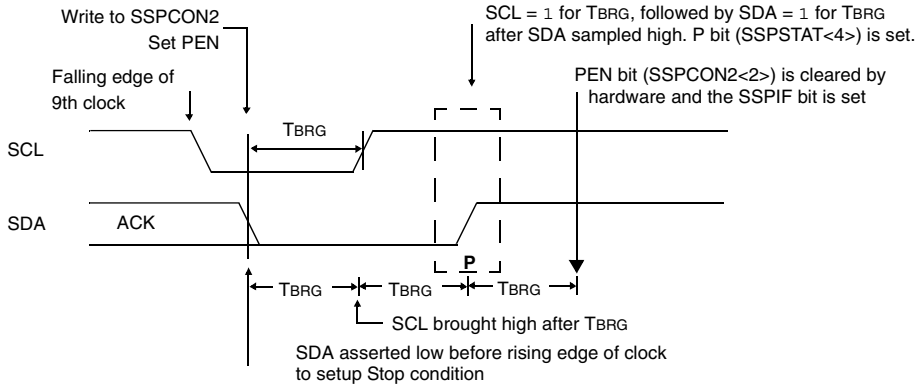
If the user writes the SSPBUF when a Stop sequence is in progress, then the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

FIGURE 17-23: ACKNOWLEDGE SEQUENCE WAVEFORM



Note: TBRG = one Baud Rate Generator period.

FIGURE 17-24: STOP CONDITION RECEIVE OR TRANSMIT MODE



Note: TBRG = one Baud Rate Generator period.

REGISTER 19-31: BRGCON3: BAUD RATE CONTROL REGISTER 3

U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	WAKFIL	—	—	—	SEG2PH2(1)	SEG2PH1(1)	SEG2PH0(1)
bit 7							bit 0

bit 7 **Unimplemented:** Read as '0'

bit 6 **WAKFIL:** Selects CAN bus Line Filter for Wake-up bit
1 = Use CAN bus line filter for wake-up
0 = CAN bus line filter is not used for wake-up

bit 5-3 **Unimplemented:** Read as '0'

bit 2-0 **SEG2PH2:SEG2PH0:** Phase Segment 2 Time Select bits(1)
111 = Phase Segment 2 Time = 8 x TQ
110 = Phase Segment 2 Time = 7 x TQ
101 = Phase Segment 2 Time = 6 x TQ
100 = Phase Segment 2 Time = 5 x TQ
011 = Phase Segment 2 Time = 4 x TQ
010 = Phase Segment 2 Time = 3 x TQ
001 = Phase Segment 2 Time = 2 x TQ
000 = Phase Segment 2 Time = 1 x TQ

Note 1: Ignored if SEG2PHTS bit (BRGCON2<7>) is clear.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

19.2.5 CAN MODULE I/O CONTROL REGISTER

This register controls the operation of the CAN module's I/O pins in relation to the rest of the microcontroller.

REGISTER 19-32: CIOCON: CAN I/O CONTROL REGISTER

U-0	U-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	—	ENDRHI	CANCAP	—	—	—	—
bit 7							bit 0

bit 7-6 **Unimplemented**: Read as '0'

bit 5 **ENDRHI:** Enable Drive High bit
1 = CANTX pin will drive VDD when recessive
0 = CANTX pin will tri-state when recessive

bit 4 **CANCAP:** CAN Message Receive Capture Enable bit
1 = Enable CAN capture, CAN message receive signal replaces input on RC2/CCP1
0 = Disable CAN capture, RC2/CCP1 input to CCP1 module

bit 3-0 **Unimplemented:** Read as '0'

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

19.6 Message Acceptance Filters and Masks

The message acceptance filters and masks are used to determine if a message in the message assembly buffer should be loaded into either of the receive buffers. Once a valid message has been received into the MAB, the identifier fields of the message are compared to the filter values. If there is a match, that message will be loaded into the appropriate receive buffer. The filter masks are used to determine which bits in the identifier are examined with the filters. A truth table is shown below in Table 19-2 that indicates how each bit in the identifier is compared to the masks and filters to determine if a message should be loaded into a receive buffer. The mask essentially determines which bits to apply the acceptance filters to. If any mask bit is set to a zero, then that bit will automatically be accepted regardless of the filter bit.

TABLE 19-2: FILTER/MASK TRUTH TABLE

Mask bit n	Filter bit n	Message Identifier bit n001	Accept or Reject bit n
0	x	x	Accept
1	0	0	Accept
1	0	1	Reject
1	1	0	Reject
1	1	1	Accept

Legend: x = don't care

As shown in the receive buffer block diagram (Figure 19-4), acceptance filters RXF0 and RXF1 and filter mask RXM0 are associated with RXB0. Filters RXF2, RXF3, RXF4 and RXF5 and mask RXM1 are associated with RXB1. When a filter matches and a message is loaded into the receive buffer, the filter number that enabled the message reception is loaded into the FILHIT bit(s).

For RXB1, the RXB1CON register contains the FILHIT<2:0> bits. They are coded as follows:

- 101 = Acceptance Filter 5 (RXF5)
- 100 = Acceptance Filter 4 (RXF4)
- 011 = Acceptance Filter 3 (RXF3)
- 010 = Acceptance Filter 2 (RXF2)
- 001 = Acceptance Filter 1 (RXF1)
- 000 = Acceptance Filter 0 (RXF0)

Note: '000' and '001' can only occur if the RXB0DBEN bit is set in the RXB0CON register allowing RXB0 messages to rollover into RXB1.

The coding of the RXB0DBEN bit enables these three bits to be used similarly to the FILHIT bits and to distinguish a hit on filter RXF0 and RXF1, in either RXB0, or after a rollover into RXB1.

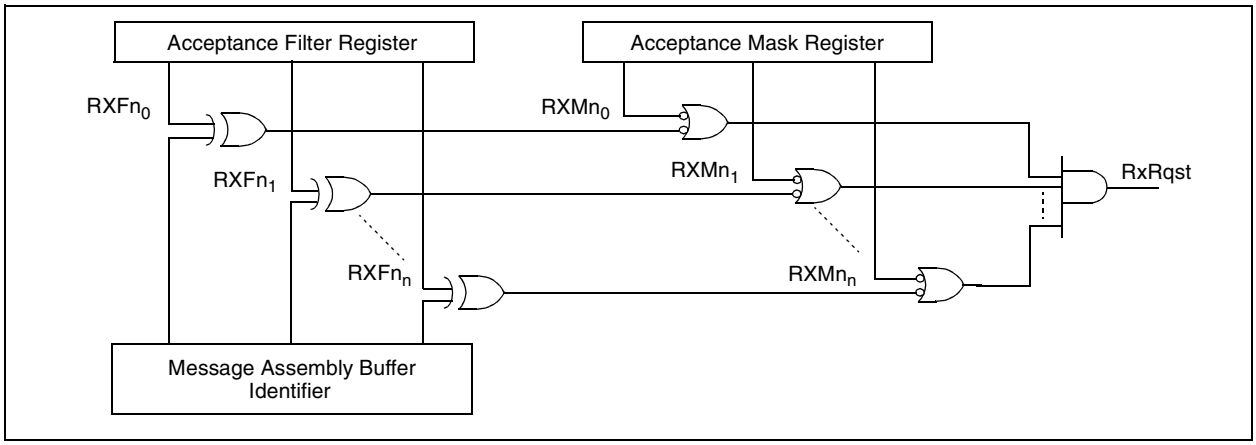
- 111 = Acceptance Filter 1 (RXF1)
- 110 = Acceptance Filter 0 (RXF0)
- 001 = Acceptance Filter 1 (RXF1)
- 000 = Acceptance Filter 0

If the RXB0DBEN bit is clear, there are six codes corresponding to the six filters. If the RXB0DBEN bit is set, there are six codes corresponding to the six filters plus two additional codes corresponding to RXF0 and RXF1 filters that rollover into RXB1.

If more than one acceptance filter matches, the FILHIT bits will encode the binary value of the lowest numbered filter that matched. In other words, if filter RXF2 and filter RXF4 match, FILHIT will be loaded with the value for RXF2. This essentially prioritizes the acceptance filters with a lower number filter having higher priority. Messages are compared to filters in ascending order of filter number.

The mask and filter registers can only be modified when the PIC18FXX8 is in Configuration mode. The mask and filter registers cannot be read outside of Configuration mode. When outside of Configuration mode, all mask and filter registers will be read as '0'.

FIGURE 19-6: MESSAGE ACCEPTANCE MASK AND FILTER OPERATION



20.2 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 12 TAD per 10-bit conversion. The source of the A/D conversion clock is software selectable. The seven possible options for TAD are:

- 2 TOSC
- 4 TOSC
- 8 TOSC
- 16 TOSC
- 32 TOSC
- 64 TOSC
- Internal RC oscillator.

For correct A/D conversions, the A/D conversion clock (TAD) must be selected to ensure a minimum TAD time of 1.6 µs.

Table 20-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

20.3 Configuring Analog Port Pins

The ADCON1, TRISA and TRISE registers control the operation of the A/D port pins. The port pins that are desired as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS2:CHS0 bits and the TRIS bits.

Note 1: When reading the port register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will not affect the conversion accuracy.

2: Analog levels on any pin that is defined as a digital input (including the AN4:AN0 pins) may cause the input buffer to consume current that is out of the device's specification.

TABLE 20-1: TAD vs. DEVICE OPERATING FREQUENCIES

AD Clock Source (TAD)		Device Frequency			
Operation	**ADCS2:ADCS0**	**20 MHz**	**5 MHz**	**1.25 MHz**	**333.33 kHz**
2 TOSC	000	100 ns(2)	400 ns(2)	1.6 µs	6 µs
4 TOSC	100	200 ns(2)	800 ns(2)	3.2 µs	12 µs
8 TOSC	001	400 ns(2)	1.6 µs	6.4 µs	24 µs(3)
16 TOSC	101	800 ns(2)	3.2 µs	12.8 µs	48 µs(3)
32 TOSC	010	1.6 µs	6.4 µs	25.6 µs(3)	96 µs(3)
64 TOSC	110	3.2 µs	12.8 µs	51.2 µs(3)	192 µs(3)
RC	011	2-6 µs(1)	2-6 µs(1)	2-6 µs(1)	2-6 µs(1)

Legend: Shaded cells are outside of recommended range.

Note 1: The RC source has a typical TAD time of 4 µs.

2: These values violate the minimum required TAD time.

3: For faster conversion times, the selection of another clock source is recommended.

TABLE 20-2: TAD vs. DEVICE OPERATING FREQUENCIES (FOR EXTENDED, LF DEVICES)

AD Clock Source (TAD)		Device Frequency			
Operation	**ADCS2:ADCS0**	**4 MHz**	**2 MHz**	**1.25 MHz**	**333.33 kHz**
2 TOSC	000	500 ns(2)	1.0 µs(2)	1.6 µs(2)	6 µs
4 TOSC	100	1.0 µs(2)	2.0 µs(2)	3.2 µs(2)	12 µs
8 TOSC	001	2.0 µs(2)	4.0 µs	6.4 µs	24 µs(3)
16 TOSC	101	4.0 µs(2)	8.0 µs	12.8 µs	48 µs(3)
32 TOSC	010	8.0 µs	16.0 µs	25.6 µs(3)	96 µs(3)
64 TOSC	110	16.0 µs	32.0 µs	51.2 µs(3)	192 µs(3)
RC	011	3-9 µs(1)	3-9 µs(1)	3-9 µs(1)	3-9 µs(1)

Legend: Shaded cells are outside of recommended range.

Note 1: The RC source has a typical TAD time of 6 µs.

2: These values violate the minimum required TAD time.

3: For faster conversion times, the selection of another clock source is recommended.

NOTES:

26.14 PICSTART Plus Development Programmer

The PICSTART Plus development programmer is an easy-to-use, low-cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. The PICSTART Plus development programmer supports most PICmicro devices up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus development programmer is CE compliant.

26.15 PICDEM 1 PICmicro Demonstration Board

The PICDEM 1 demonstration board demonstrates the capabilities of the PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The sample microcontrollers provided with the PICDEM 1 demonstration board can be programmed with a PRO MATE II device programmer or a PICSTART Plus development programmer. The PICDEM 1 demonstration board can be connected to the MPLAB ICE in-circuit emulator for testing. A prototype area extends the circuitry for additional application components. Features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs.

26.16 PICDEM.net Internet/Ethernet Demonstration Board

The PICDEM.net demonstration board is an Internet/Ethernet demonstration board using the PIC18F452 microcontroller and TCP/IP firmware. The board supports any 40-pin DIP device that conforms to the standard pinout used by the PIC16F877 or PIC18C452. This kit features a user friendly TCP/IP stack, web server with HTML, a 24L256 Serial EEPROM for Xmodem download to web pages into Serial EEPROM, ICSP/MPLAB ICD 2 interface connector, an Ethernet interface, RS-232 interface and a 16 x 2 LCD display. Also included is the book and CD-ROM *"TCP/IP Lean, Web Servers for Embedded Systems,"* by Jeremy Bentham

26.17 PICDEM 2 Plus Demonstration Board

The PICDEM 2 Plus demonstration board supports many 18, 28 and 40-pin microcontrollers, including PIC16F87X and PIC18FXX2 devices. All the necessary hardware and software is included to run the demonstration programs. The sample microcontrollers provided with the PICDEM 2 demonstration board can be programmed with a PRO MATE II device programmer, PICSTART Plus development programmer, or MPLAB ICD 2 with a Universal Programmer Adapter. The MPLAB ICD 2 and MPLAB ICE in-circuit emulators may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area extends the circuitry for additional application components. Some of the features include an RS-232 interface, a 2 x 16 LCD display, a piezo speaker, an on-board temperature sensor, four LEDs and sample PIC18F452 and PIC16F877 Flash microcontrollers.

26.18 PICDEM 3 PIC16C92X Demonstration Board

The PICDEM 3 demonstration board supports the PIC16C923 and PIC16C924 in the PLCC package. All the necessary hardware and software is included to run the demonstration programs.

26.19 PICDEM 4 8/14/18-Pin Demonstration Board

The PICDEM 4 can be used to demonstrate the capabilities of the 8, 14 and 18-pin PIC16XXXX and PIC18XXXX MCUs, including the PIC16F818/819, PIC16F87/88, PIC16F62XA and the PIC18F1320 family of microcontrollers. PICDEM 4 is intended to showcase the many features of these low pin count parts, including LIN and Motor Control using ECCP. Special provisions are made for low-power operation with the supercapacitor circuit and jumpers allow on-board hardware to be disabled to eliminate current draw in this mode. Included on the demo board are provisions for Crystal, RC or Canned Oscillator modes, a five volt regulator for use with a nine volt wall adapter or battery, DB-9 RS-232 interface, ICD connector for programming via ICSP and development with MPLAB ICD 2, 2 x 16 liquid crystal display, PCB footprints for H-Bridge motor driver, LIN transceiver and EEPROM. Also included are: header for expansion, eight LEDs, four potentiometers, three push buttons and a prototyping area. Included with the kit is a PIC16F627A and a PIC18F1320. Tutorial firmware is included along with the User's Guide.

NOTES:

TABLE 27-20: MASTER SSP I²C™ BUS DATA REQUIREMENTS

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
100	THIGH	Clock High Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
101	TLOW	Clock Low Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
102	TR	SDA and SCL Rise Time	100 kHz mode	—	1000	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(1)	—	300	ns	
103	TF	SDA and SCL Fall Time	100 kHz mode	—	300	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(1)	—	100	ns	
90	TSU:STA	Start Condition Setup Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	Only relevant for Repeated Start condition
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
91	THD:STA	Start Condition Hold Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	After this period, the first clock pulse is generated
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
106	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	ms	
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250	—	ns	**(Note 2)**
			400 kHz mode	100	—	ns	
92	TSU:STO	Stop Condition Setup Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
109	TAA	Output Valid from Clock	100 kHz mode	—	3500	ns	
			400 kHz mode	—	1000	ns	
			1 MHz mode(1)	—	—	ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7	—	ms	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	ms	
D102	CB	Bus Capacitive Loading		—	400	pF	

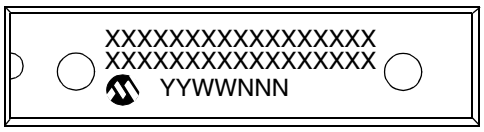
Note 1: Maximum pin capacitance = 10 pF for all I²C™ pins.

2: A Fast mode I²C bus device can be used in a Standard mode I²C bus system, but parameter #107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the low period of the SCL signal. If such a device does stretch the low period of the SCL signal, it must output the next data bit to the SDA line.
Before the SCL line is released, parameter #102 + parameter #107 = 1000 + 250 = 1250 ns (for 100 kHz mode).

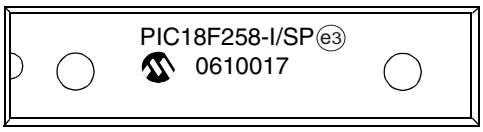
29.0 PACKAGING INFORMATION

29.1 Package Marking Information

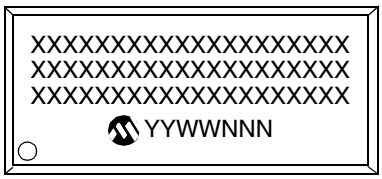
28-Lead SPDIP



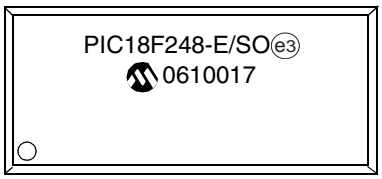
Example



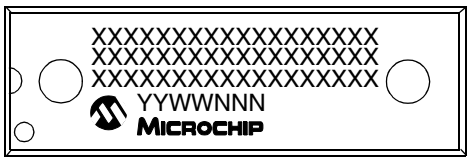
28-Lead SOIC



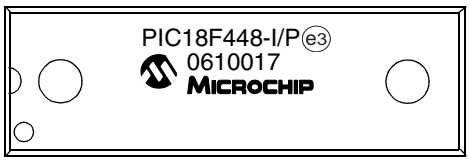
Example



40-Lead PDIP



Example



Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

APPENDIX C: DEVICE MIGRATIONS

This section is intended to describe the functional and electrical specification differences when migrating between functionally similar devices (such as from a PIC16C74A to a PIC16C74B).

Not Applicable

APPENDIX D: MIGRATING FROM OTHER PICmicro® DEVICES

This discusses some of the issues in migrating from other PICmicro devices to the PIC18FXX8 family of devices.

D.1 PIC16CXXX to PIC18FXX8

See Application Note *AN716 "Migrating Designs from PIC16C74A/74B to PIC18C442"* (DS00716).

D.2 PIC17CXXX to PIC18FXX8

See Application Note *AN726 "PIC17CXXX to PIC18CXXX Migration"* (DS00726).

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